

CUSTOMER : \_\_\_\_\_.

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# PRODUCT FAMILY DATA SHEET



## *6030 2Cup 2Chip*

MODEL NAME : LEMWS68T80 Series



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## 1. Features

- Lighting Color : White
- Lead Frame Type LED Package : 6.0×3.0×0.8 mm (L×W×H)
- Viewing Angle : 118°
- Chip Material : InGaN
- Soldering Method : Reflow Soldering
- Taping : 12 mm conductive black carrier tape & antistatic clear cover tape.

4,000pcs/reel, Φ178mm wheel

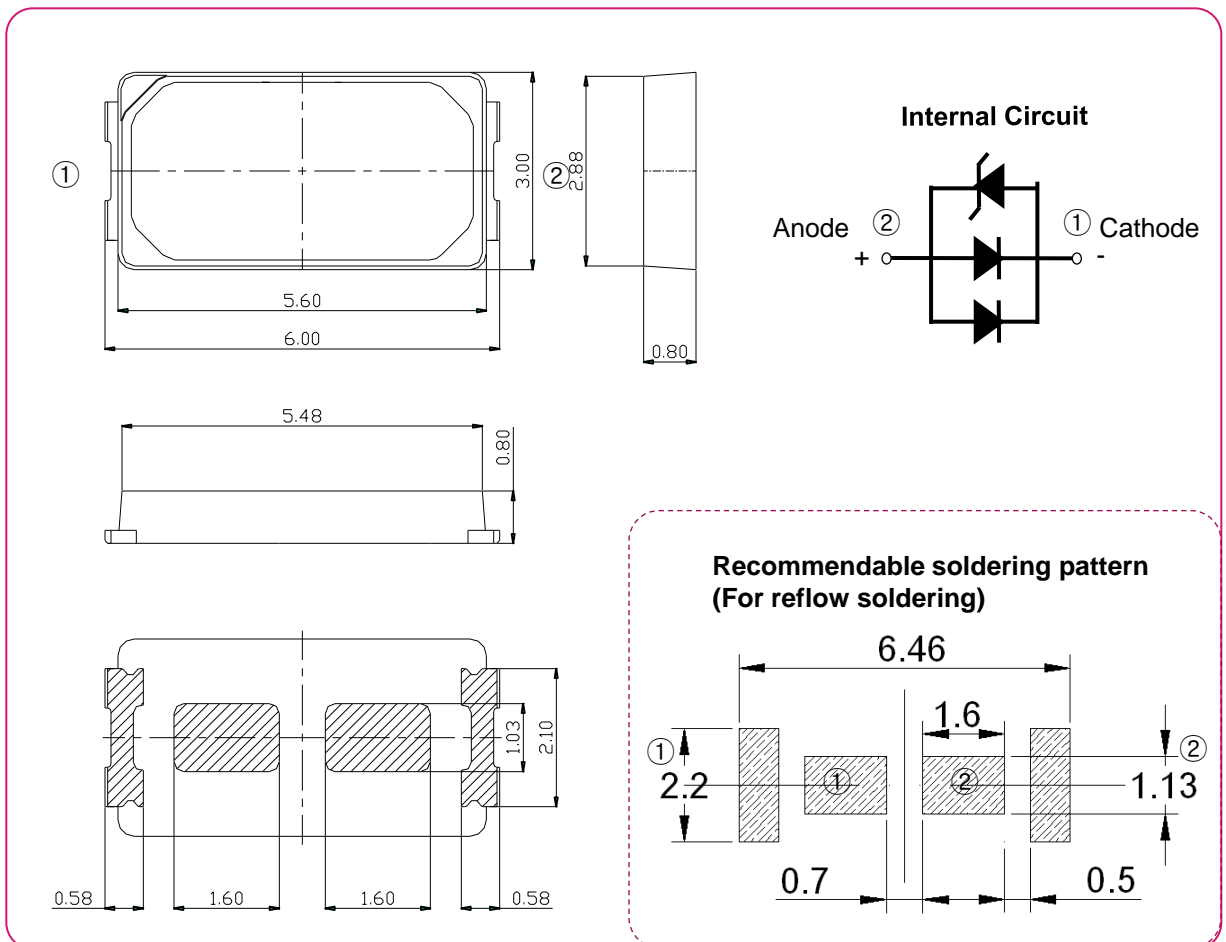
- UL-recognized Component (E356829)
- RoHS Compliant

## 2. Applications

- Interior and Exterior Illumination

## 3. Outline Dimensions

( Unit : mm )



▪ Tolerance unless otherwise mentioned are  $\pm 0.1$  mm

## 4. Absolute Maximum Ratings

( Ta = 25°C )

Item	Symbol	Rating	Unit
Forward Current	If	240	mA
Peak Pulse Forward Current* <sup>1)</sup>	I <sub>fp</sub>	270	mA
Operating Temperature	Topr	-30 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +100	°C
Junction Temperature	Tj	110	°C
Soldering Temperature	JEDEC-J-STD-020D		
ESD Classification	Class 2 (JESD22-A114)		

\*1) Pulse width ≤ 10ms and duty cycle ≤ 10%

※ Operating the LED beyond the listed maximum ratings may affect device reliability and cause permanent damage.

These or any other conditions beyond those indicated under recommended operating conditions are not implied.

The exposure to the absolute maximum rated conditions may affect device reliability.

※ The LEDs are not designed to be driven in reverse bias.

## 5. Electro - Optical Characteristics

( Ta = 25°C, If = 130mA )

Item	Symbol	CCT	Min.	Typ.	Max.	Unit
Luminous Flux	Φ <sub>v</sub>	6500 (F)	47.4	53.8	60.0	lm
		5700 (G)	47.0	53.2	61.0	
		5000 (H)	47.5	52.8	61.5	
		4000 (J)	46.4	51.8	60.0	
		3500 (K)	45.8	51.5	59.5	
		3000 (L)	44.6	48.4	58.0	
		2700 (M)	42.6	46.5	55.3	
Forward Voltage	V <sub>f</sub>	All	2.80	3.00	3.20	V
Color	C <sub>x</sub> / C <sub>y</sub>	All	Refer to 'Chromaticity Bins'			-
Viewing Angle	2Θ <sub>1/2</sub>	All	-	118	-	deg
Color Rendering Index (Ra)	-	J, K, L, M	80	-	-	-
Thermal Resistance, Junction to Solder Point	R <sub>th j-s</sub>	All	-	12	-	°C/W
Typical Temperature Coefficient of Forward Voltage* <sup>1)</sup>	ΔV <sub>f</sub> / ΔT <sub>j</sub>	All	-1.0	-	-3.0	mV/°C

※ These values are measured by the LG Innotek optical spectrum analyzer within the following tolerances.

Luminous Flux (Φ<sub>v</sub>) : ± 7%, Forward Voltage (V<sub>f</sub>) : ± 0.1V, Color Value : ± 0.005, CRI Value : ± 2,

## 5. Electro - Optical Characteristics

CCT	If (mA)	Vf (V)	Power (W)	$\Phi_v$ (lm)	lm/W
6500K (F)	70	2.87	0.201	30.4	151
	110	2.96	0.326	46.3	142
	130 (Typ.)	3.00	0.390	53.8	138
	150	3.04	0.456	61.2	134
	180	3.09	0.556	71.9	129
	240	3.18	0.763	92.2	121
5700K (G)	70	2.87	0.201	30.1	150
	110	2.96	0.326	45.8	141
	130 (Typ.)	3.00	0.390	53.2	136
	150	3.04	0.456	60.5	133
	180	3.09	0.556	71.1	128
	240	3.18	0.763	91.2	119
5000K (H)	70	2.87	0.201	30.0	149
	110	2.96	0.326	45.5	140
	130 (Typ.)	3.00	0.390	52.8	135
	150	3.04	0.456	59.9	131
	180	3.09	0.556	70.3	126
	240	3.18	0.763	89.5	117
4000K (J)	70	2.87	0.201	29.5	147
	110	2.96	0.326	44.6	137
	130 (Typ.)	3.00	0.390	51.8	133
	150	3.04	0.456	58.8	129
	180	3.09	0.556	68.8	124
	240	3.18	0.763	87.9	115
3500K (K)	70	2.87	0.201	29.1	145
	110	2.96	0.326	44.3	136
	130 (Typ.)	3.00	0.390	51.5	132
	150	3.04	0.456	58.6	129
	180	3.09	0.556	68.9	124
	240	3.18	0.763	88.6	116
3000K (L)	70	2.87	0.201	27.6	137
	110	2.96	0.326	41.8	128
	130 (Typ.)	3.00	0.390	48.4	124
	150	3.04	0.456	54.9	120
	180	3.09	0.556	64.3	116
	240	3.18	0.763	82.0	107
2700K (M)	70	2.87	0.201	26.4	131
	110	2.96	0.326	40.0	123
	130 (Typ.)	3.00	0.390	46.5	119
	150	3.04	0.456	52.8	116
	180	3.09	0.556	61.7	111
	240	3.18	0.763	78.7	103

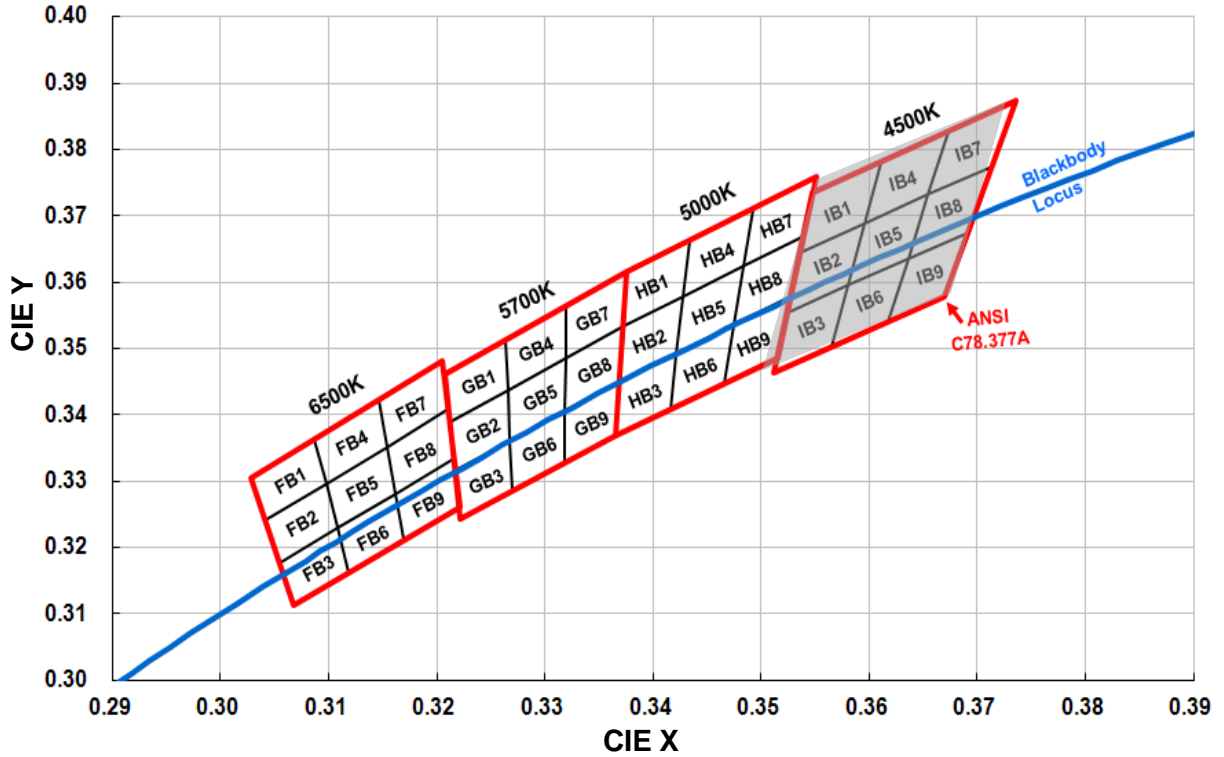
※  $\Phi_v$  values are for representative references only.

## 6. Flux Characteristics and Order Code

Color	CRI	CCT	Vf @ 130mA [V]	Luminous Flux [lm] @ 130mA			Order Code
				Bin Code	Min.	Max.	
Cool	80	6500 (F)	2.80 ~ 2.90 (9) 2.90 ~ 3.00 (0) 3.00 ~ 3.10 (1) 3.10 ~ 3.20 (2)	T0	47.4	60.0	LEMWS68T80FZxxxx
				T1	47.4	53.5	
				T2	53.5	60.0	
Cool	80	5700 (G)	2.80 ~ 2.90 (9) 2.90 ~ 3.00 (0) 3.00 ~ 3.10 (1) 3.10 ~ 3.20 (2)	T0	47.0	61.0	LEMWS68T80GZxxxx
				T1	47.0	54.0	
				T2	54.0	61.0	
Cool	80	5000 (H)	2.80 ~ 2.90 (9) 2.90 ~ 3.00 (0) 3.00 ~ 3.10 (1) 3.10 ~ 3.20 (2)	T0	47.5	61.5	LEMWS68T80HZxxxx
				T1	47.5	54.5	
				T2	54.5	61.5	
Neutral	80	4000 (J)	2.80 ~ 2.90 (9) 2.90 ~ 3.00 (0) 3.00 ~ 3.10 (1) 3.10 ~ 3.20 (2)	T0	46.4	60.0	LEMWS68T80JZxxxx
				T1	46.4	53.0	
				T2	53.0	60.0	
Warm	80	3500 (K)	2.80 ~ 2.90 (9) 2.90 ~ 3.00 (0) 3.00 ~ 3.10 (1) 3.10 ~ 3.20 (2)	T0	45.8	59.5	LEMWS68T80KZxxxx
				T1	45.8	52.5	
				T2	52.5	59.5	
Warm	80	3000 (L)	2.80 ~ 2.90 (9) 2.90 ~ 3.00 (0) 3.00 ~ 3.10 (1) 3.10 ~ 3.20 (2)	T0	44.6	58.0	LEMWS68T80LZxxxx
				T1	44.6	51.0	
				T2	51.0	58.0	
Warm	80	2700 (M)	2.80 ~ 2.90 (9) 2.90 ~ 3.00 (0) 3.00 ~ 3.10 (1) 3.10 ~ 3.20 (2)	T0	42.6	55.3	LEMWS68T80MZxxxx
				T1	42.6	48.9	
				T2	48.9	55.3	

## 7. Chromaticity Bins

LG Innotek complies with the ANSI C78.377A standard for its chromaticity bin structure. For each ANSI quadrangle for the CCT range of 4500K to 6500K, LG Innotek provides 9 micro bins.



Bin	CIE X	CIE Y	Bin	CIE X	CIE Y	Bin	CIE X	CIE Y	Bin	CIE X	CIE Y
FB1	0.3028	0.3304	GB1	0.3207	0.3462	HB1	0.3376	0.3616	IB1	0.3548	0.3736
	0.3087	0.3363		0.3263	0.3513		0.3434	0.3664		0.3611	0.3782
	0.3098	0.3296		0.3266	0.3437		0.3428	0.3579		0.3595	0.3689
	0.3041	0.3240		0.3212	0.3389		0.3373	0.3534		0.3536	0.3646
FB2	0.3041	0.3240	GB2	0.3212	0.3389	HB2	0.3373	0.3534	IB2	0.3536	0.3646
	0.3098	0.3296		0.3266	0.3437		0.3428	0.3579		0.3595	0.3689
	0.3108	0.3229		0.3268	0.3361		0.3422	0.3494		0.3580	0.3596
	0.3055	0.3177		0.3217	0.3316		0.3369	0.3451		0.3524	0.3555
FB3	0.3055	0.3177	GB3	0.3217	0.3316	HB3	0.3369	0.3451	IB3	0.3524	0.3555
	0.3108	0.3229		0.3268	0.3361		0.3422	0.3494		0.3580	0.3596
	0.3119	0.3162		0.3270	0.3285		0.3416	0.3408		0.3565	0.3503
	0.3068	0.3113		0.3222	0.3243		0.3366	0.3369		0.3512	0.3465
FB4	0.3087	0.3363	GB4	0.3263	0.3513	HB4	0.3434	0.3664	IB4	0.3611	0.3782
	0.3146	0.3422		0.3320	0.3565		0.3493	0.3712		0.3673	0.3828
	0.3154	0.3352		0.3319	0.3485		0.3484	0.3624		0.3655	0.3732
	0.3098	0.3296		0.3266	0.3437		0.3428	0.3579		0.3595	0.3689

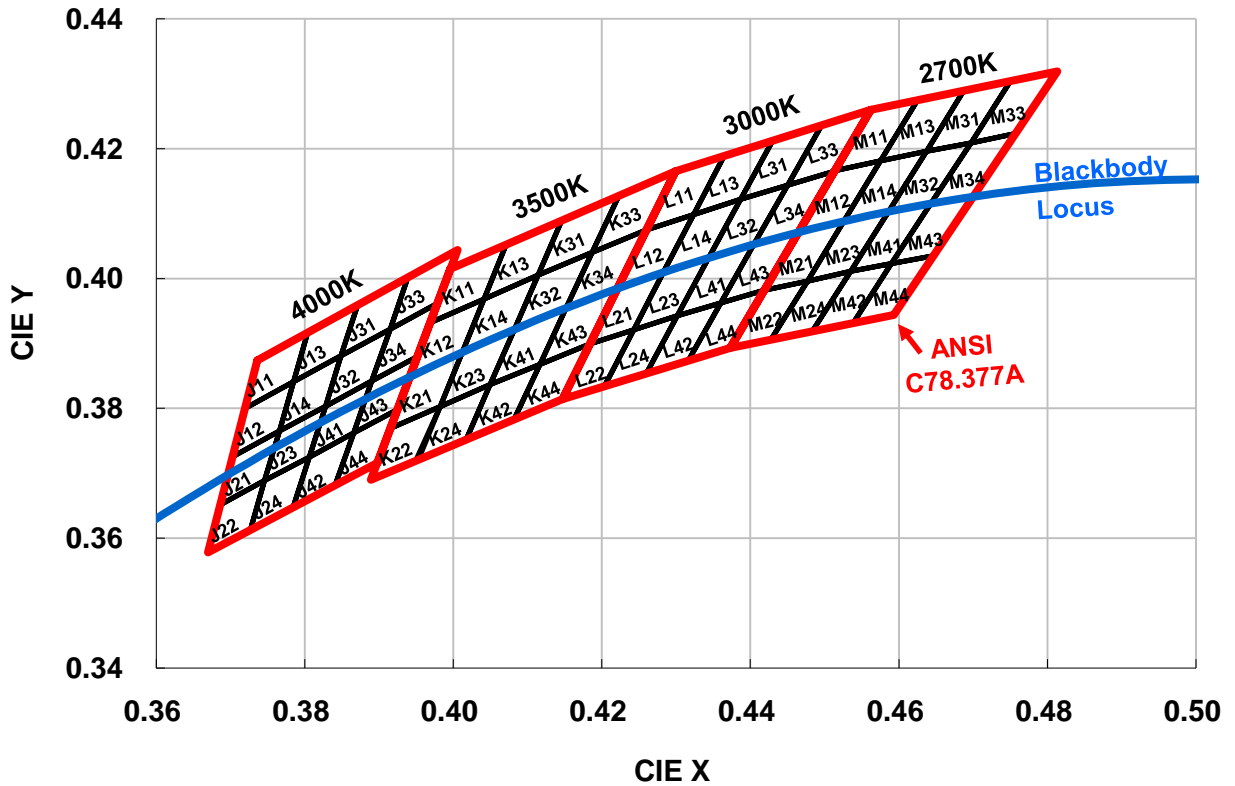
## 7. Chromaticity Bins (Continued)

Bin	CIE X	CIE Y	Bin	CIE X	CIE Y	Bin	CIE X	CIE Y	Bin	CIE X	CIE Y
FB5	0.3098	0.3296	GB5	0.3266	0.3437	HB5	0.3428	0.3579	IB5	0.3595	0.3689
	0.3154	0.3352		0.3319	0.3485		0.3484	0.3624		0.3655	0.3732
	0.3162	0.3282		0.3319	0.3406		0.3474	0.3536		0.3636	0.3636
	0.3108	0.3229		0.3268	0.3361		0.3422	0.3494		0.3580	0.3596
FB6	0.3108	0.3229	GB6	0.3268	0.3361	HB6	0.3422	0.3494	IB6	0.3580	0.3596
	0.3162	0.3282		0.3319	0.3406		0.3474	0.3536		0.3636	0.3636
	0.3170	0.3212		0.3318	0.3327		0.3465	0.3448		0.3617	0.3540
	0.3119	0.3162		0.3270	0.3285		0.3416	0.3408		0.3565	0.3503
FB7	0.3146	0.3422	GB7	0.3320	0.3565	HB7	0.3493	0.3712	IB7	0.3673	0.3828
	0.3205	0.3481		0.3376	0.3616		0.3551	0.3760		0.3736	0.3874
	0.3210	0.3408		0.3373	0.3534		0.3539	0.3669		0.3714	0.3775
	0.3154	0.3352		0.3319	0.3485		0.3484	0.3624		0.3655	0.3732
FB8	0.3154	0.3352	GB8	0.3319	0.3485	HB8	0.3484	0.3624	IB8	0.3655	0.3732
	0.3210	0.3408		0.3373	0.3534		0.3539	0.3669		0.3714	0.3775
	0.3216	0.3334		0.3369	0.3451		0.3527	0.3578		0.3692	0.3677
	0.3162	0.3282		0.3319	0.3406		0.3474	0.3536		0.3636	0.3636
FB9	0.3162	0.3282	GB9	0.3319	0.3406	HB9	0.3474	0.3536	IB9	0.3636	0.3636
	0.3216	0.3334		0.3369	0.3451		0.3527	0.3578		0.3692	0.3677
	0.3221	0.3261		0.3366	0.3369		0.3515	0.3487		0.3670	0.3578
	0.3170	0.3212		0.3318	0.3327		0.3465	0.3448		0.3617	0.3540



## 7. Chromaticity Bins (Continued)

LG Innotek complies with the ANSI C78.377A standard for its chromaticity bin structure. For each ANSI quadrangle for the CCT range of 2700K to 4000K, LG Innotek provides 16 micro bins.



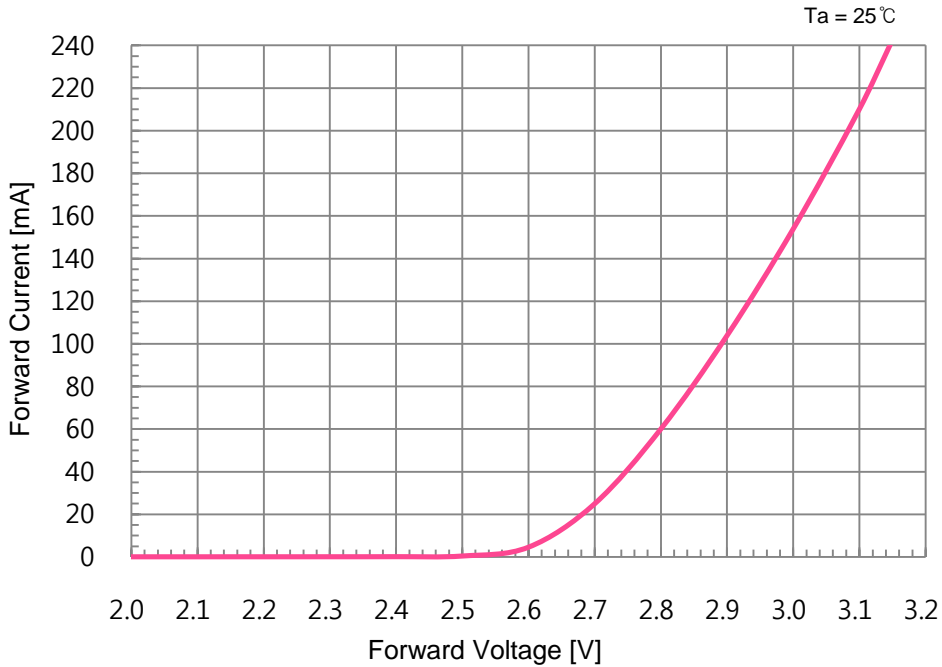
Bin	CIE X	CIE Y	Bin	CIE X	CIE Y	Bin	CIE X	CIE Y	Bin	CIE X	CIE Y
J11	0.3736	0.3874	K11	0.3996	0.4015	L11	0.4299	0.4165	M11	0.4562	0.4260
	0.3804	0.3917		0.4071	0.4052		0.4364	0.4189		0.4625	0.4275
	0.3785	0.3841		0.4041	0.3969		0.4323	0.4098		0.4575	0.4181
	0.3720	0.3800		0.3969	0.3932		0.4260	0.4075		0.4513	0.4166
J12	0.3720	0.3800	K12	0.3969	0.3932	L12	0.4260	0.4075	M12	0.4513	0.4166
	0.3785	0.3841		0.4041	0.3969		0.4323	0.4098		0.4575	0.4181
	0.3766	0.3765		0.4012	0.3885		0.4282	0.4008		0.4525	0.4087
	0.3703	0.3726		0.3941	0.3848		0.4221	0.3984		0.4465	0.4071
J13	0.3804	0.3917	K13	0.4071	0.4052	L13	0.4364	0.4189	M13	0.4625	0.4275
	0.3871	0.3959		0.4146	0.4089		0.4430	0.4212		0.4687	0.4289
	0.3849	0.3881		0.4114	0.4005		0.4387	0.4122		0.4637	0.4196
	0.3785	0.3841		0.4041	0.3969		0.4323	0.4098		0.4575	0.4181
J14	0.3785	0.3841	K14	0.4041	0.3969	L14	0.4323	0.4098	M14	0.4575	0.4181
	0.3849	0.3881		0.4114	0.4005		0.4387	0.4122		0.4637	0.4196
	0.3828	0.3803		0.4082	0.3922		0.4344	0.4032		0.4586	0.4103
	0.3766	0.3765		0.4012	0.3885		0.4282	0.4008		0.4525	0.4087

## 7. Chromaticity Bins (Continued)

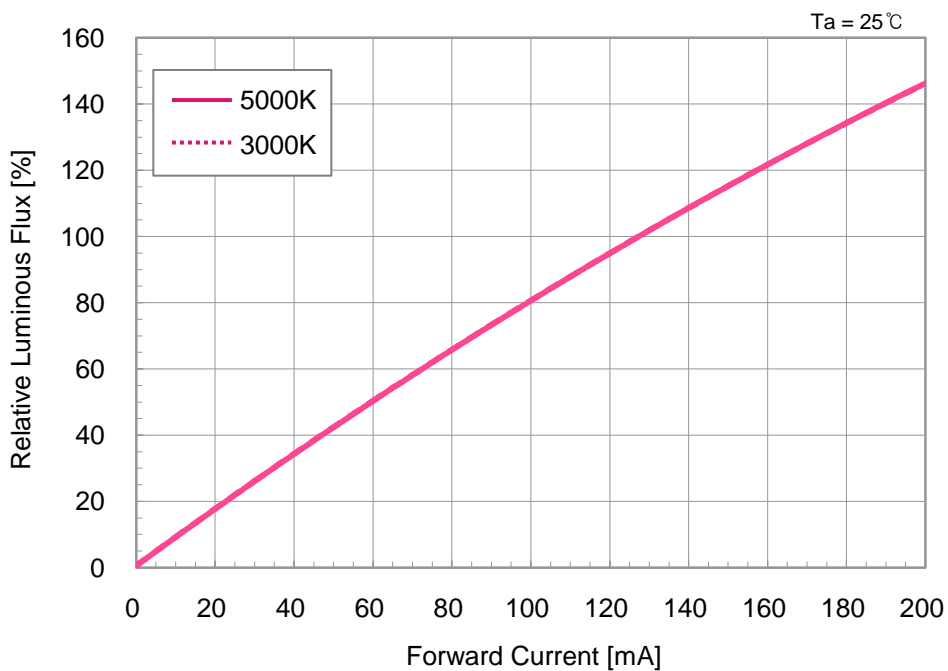
Bin	CIE X	CIE Y	Bin	CIE X	CIE Y	Bin	CIE X	CIE Y	Bin	CIE X	CIE Y
J21	0.3703	0.3726	K21	0.3941	0.3848	L21	0.4221	0.3984	M21	0.4465	0.4071
	0.3766	0.3765		0.4012	0.3885		0.4282	0.4008		0.4525	0.4087
	0.3746	0.3689		0.3982	0.3803		0.4243	0.3921		0.4477	0.3996
	0.3687	0.3652		0.3915	0.3769		0.4184	0.3899		0.4419	0.3982
J22	0.3687	0.3652	K22	0.3915	0.3769	L22	0.4184	0.3899	M22	0.4419	0.3982
	0.3746	0.3689		0.3982	0.3803		0.4243	0.3921		0.4477	0.3996
	0.3727	0.3613		0.3950	0.3721		0.4203	0.3834		0.4428	0.3906
	0.3670	0.3578		0.3889	0.3690		0.4147	0.3814		0.4373	0.3893
J23	0.3766	0.3765	K23	0.4012	0.3885	L23	0.4282	0.4008	M23	0.4525	0.4087
	0.3828	0.3803		0.4082	0.3922		0.4344	0.4032		0.4586	0.4103
	0.3806	0.3725		0.4050	0.3837		0.4302	0.3943		0.4535	0.4011
	0.3746	0.3689		0.3982	0.3803		0.4243	0.3921		0.4477	0.3996
J24	0.3746	0.3689	K24	0.3982	0.3803	L24	0.4243	0.3921	M24	0.4477	0.3996
	0.3806	0.3725		0.4050	0.3837		0.4302	0.3943		0.4535	0.4011
	0.3784	0.3647		0.4017	0.3752		0.4260	0.3853		0.4483	0.3918
	0.3727	0.3613		0.3953	0.3721		0.4203	0.3834		0.4428	0.3906
J31	0.3871	0.3959	K31	0.4146	0.4089	L31	0.4430	0.4212	M31	0.4687	0.4289
	0.3939	0.4002		0.4223	0.4127		0.4496	0.4236		0.4750	0.4304
	0.3915	0.3922		0.4187	0.4040		0.4450	0.4144		0.4697	0.4209
	0.3849	0.3881		0.4114	0.4005		0.4387	0.4122		0.4637	0.4196
J32	0.3849	0.3881	K32	0.4114	0.4005	L32	0.4387	0.4122	M32	0.4637	0.4196
	0.3915	0.3922		0.4187	0.4040		0.4450	0.4144		0.4697	0.4209
	0.3890	0.3842		0.4151	0.3953		0.4404	0.4052		0.4643	0.4115
	0.3828	0.3803		0.4082	0.3922		0.4344	0.4032		0.4586	0.4103
J33	0.3939	0.4002	K33	0.4223	0.4127	L33	0.4496	0.4236	M33	0.4750	0.4304
	0.4006	0.4044		0.4299	0.4165		0.4562	0.4260		0.4813	0.4319
	0.3979	0.3962		0.4260	0.4075		0.4513	0.4166		0.4756	0.4223
	0.3915	0.3922		0.4187	0.4040		0.4450	0.4144		0.4697	0.4209
J34	0.3915	0.3922	K34	0.4187	0.4040	L34	0.4450	0.4144	M34	0.4697	0.4209
	0.3979	0.3962		0.4260	0.4075		0.4513	0.4166		0.4756	0.4223
	0.3952	0.3880		0.4221	0.3984		0.4465	0.4071		0.4700	0.4126
	0.3890	0.3842		0.4151	0.3953		0.4404	0.4052		0.4643	0.4115
J41	0.3828	0.3803	K41	0.4082	0.3922	L41	0.4344	0.4032	M41	0.4586	0.4103
	0.3890	0.3842		0.4151	0.3953		0.4404	0.4052		0.4643	0.4115
	0.3866	0.3762		0.4117	0.3868		0.4360	0.3962		0.4590	0.4023
	0.3806	0.3725		0.4050	0.3837		0.4302	0.3943		0.4535	0.4011
J42	0.3806	0.3725	K42	0.4050	0.3837	L42	0.4302	0.3943	M42	0.4535	0.4011
	0.3866	0.3762		0.4117	0.3868		0.4360	0.3962		0.4590	0.4023
	0.3841	0.3682		0.4082	0.3783		0.4316	0.3873		0.4538	0.3931
	0.3784	0.3647		0.4017	0.3752		0.4260	0.3853		0.4483	0.3918
J43	0.3890	0.3842	K43	0.4151	0.3953	L43	0.4404	0.4052	M43	0.4643	0.4115
	0.3952	0.3880		0.4221	0.3984		0.4465	0.4071		0.4700	0.4126
	0.3925	0.3798		0.4184	0.3899		0.4419	0.3982		0.4646	0.4035
	0.3866	0.3762		0.4117	0.3868		0.4360	0.3962		0.4590	0.4023
J44	0.3866	0.3762	K44	0.4117	0.3868	L44	0.4360	0.3962	M44	0.4590	0.4023
	0.3925	0.3798		0.4184	0.3899		0.4419	0.3982		0.4646	0.4035
	0.3898	0.3716		0.4147	0.3814		0.4373	0.3893		0.4593	0.3944
	0.3841	0.3682		0.4082	0.3783		0.4316	0.3873		0.4538	0.3931

## 8. Typical Characteristic Curves

### ▪ Forward Current vs. Forward Voltage



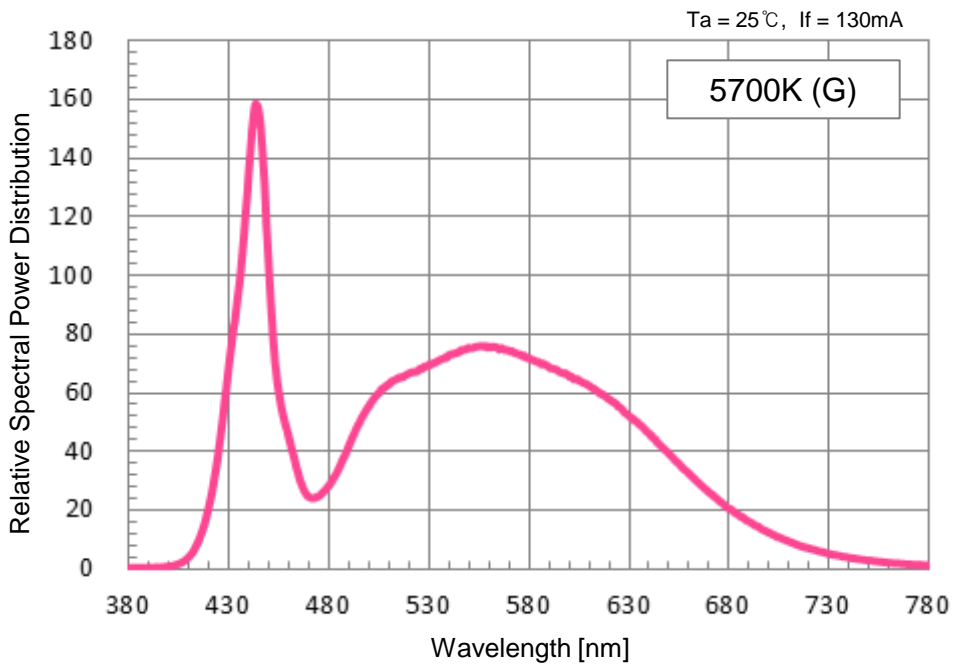
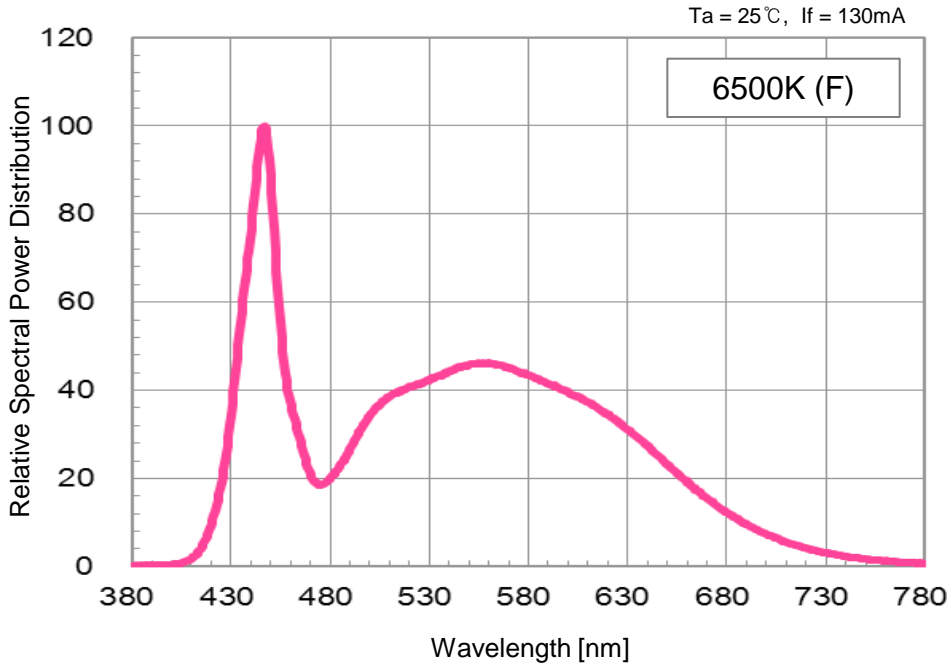
### ▪ Relative Luminous Flux vs. Forward Current



※ 5000K CCT data also applies to 5700K and 6500K CCTs and 3000K data also applies to 2700K, 3500K and 4000K CCTs.

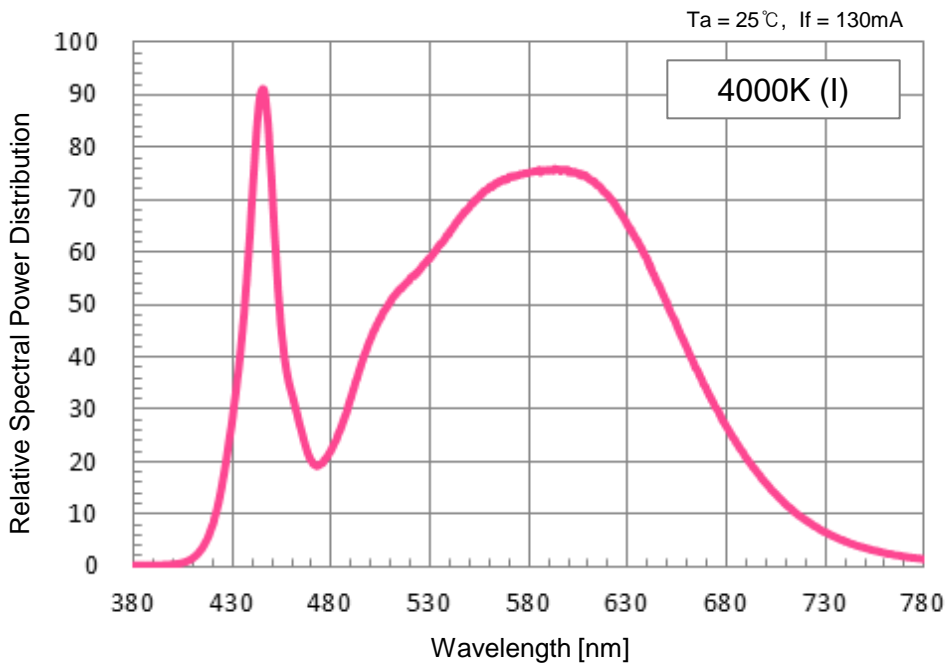
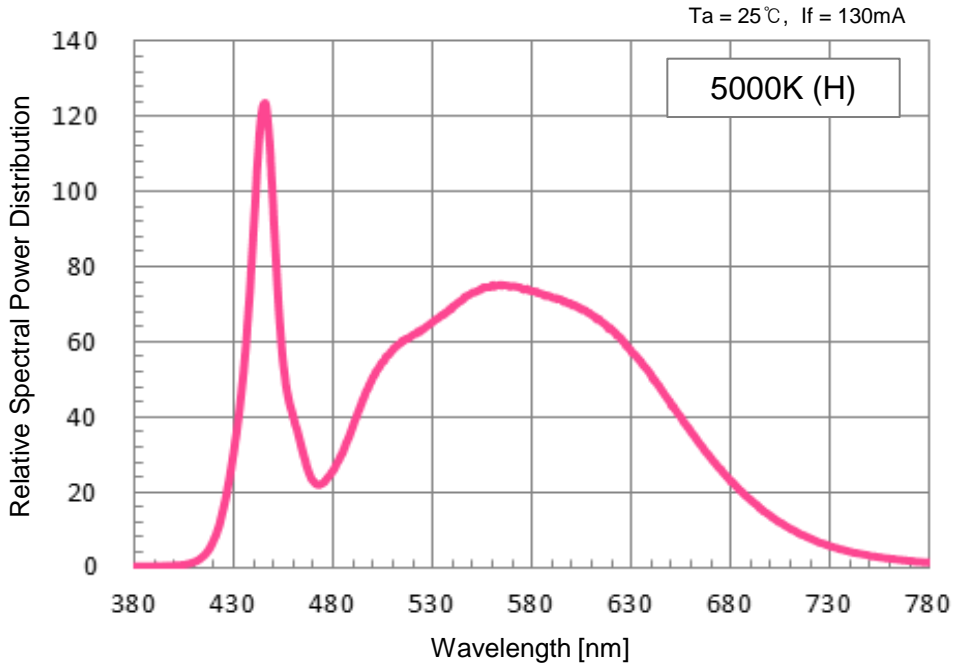
## 8. Typical Characteristic Curves

- Spectrum



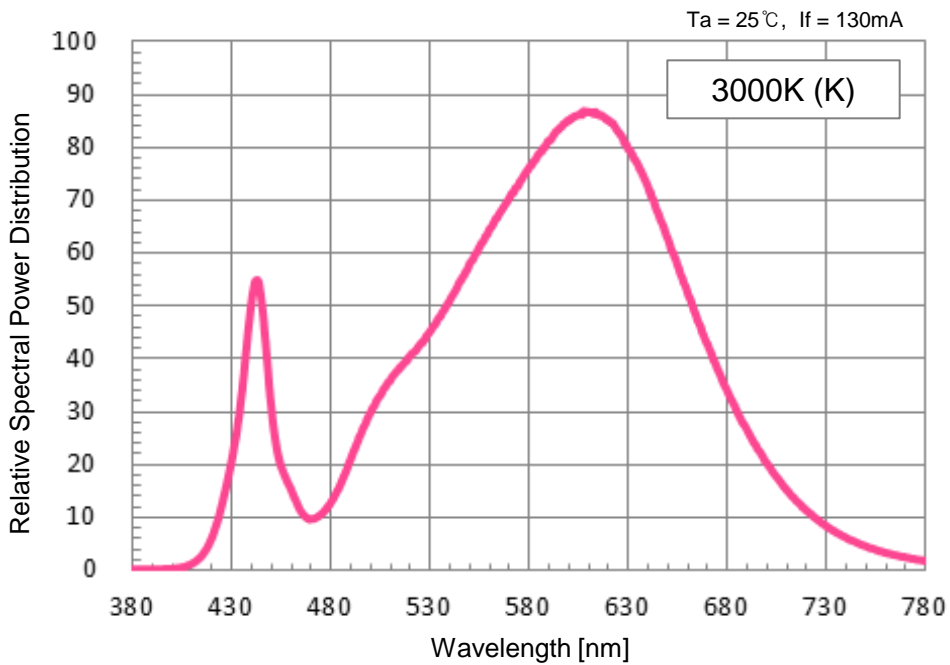
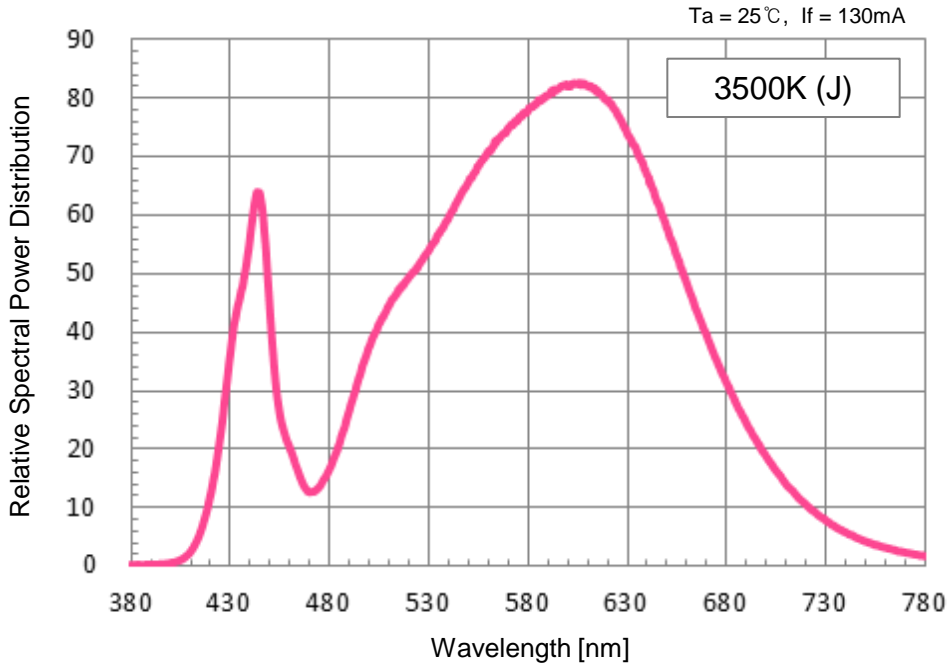
## 8. Typical Characteristic Curves

- Spectrum



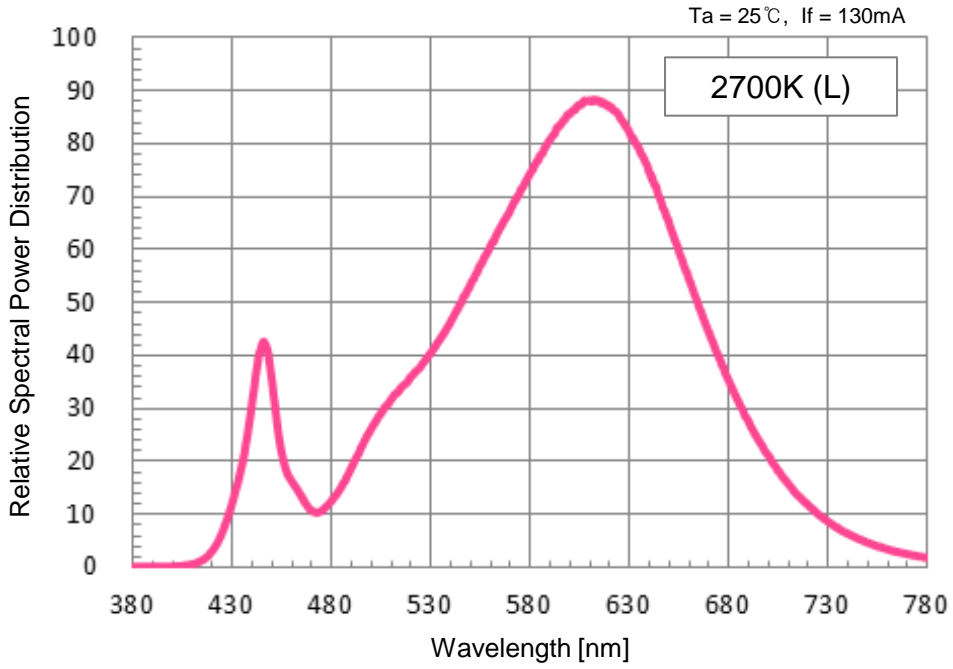
## 8. Typical Characteristic Curves

- Spectrum



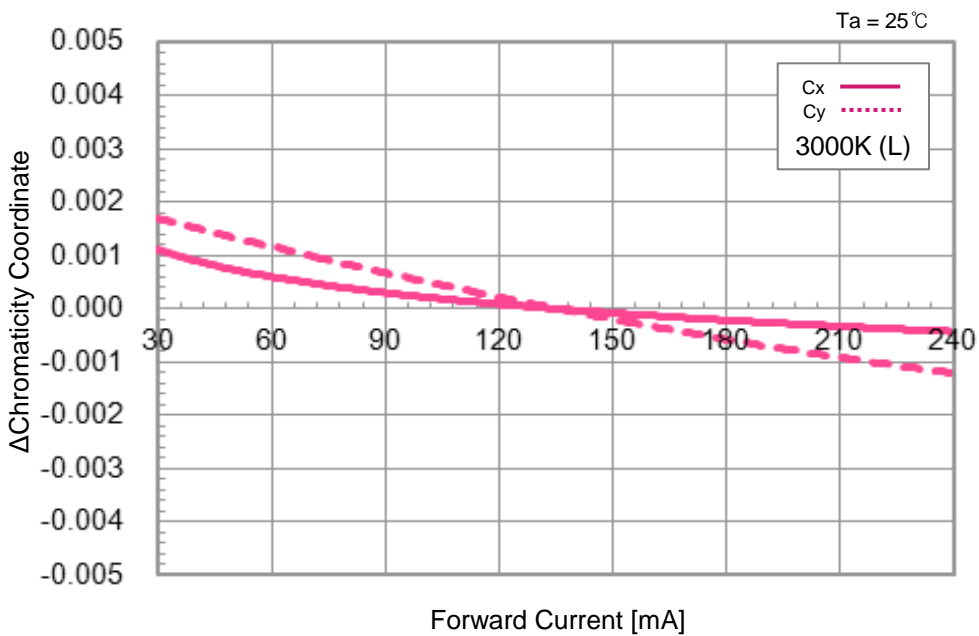
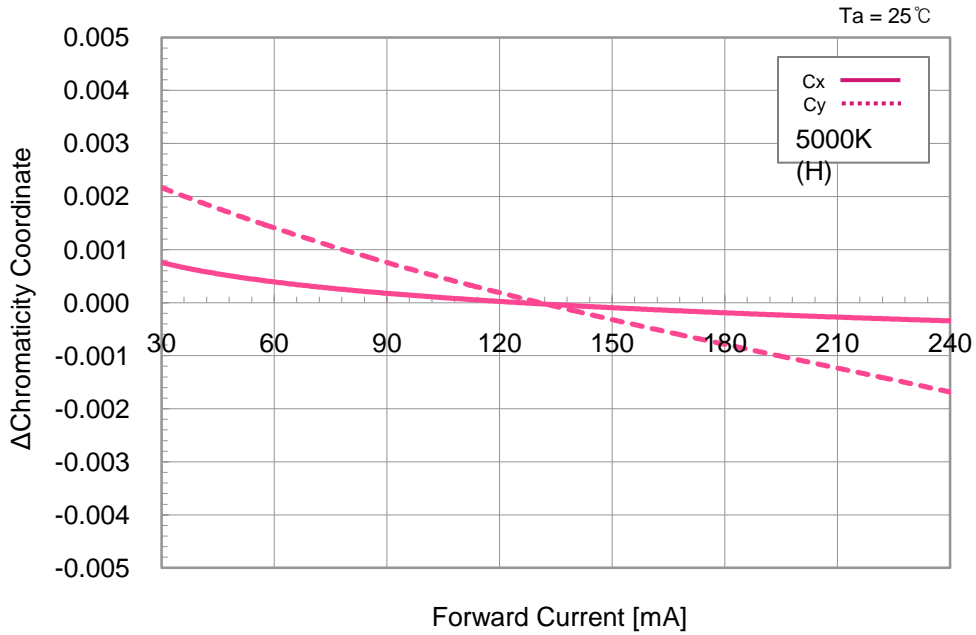
## 8. Typical Characteristic Curves

- Spectrum



## 8. Typical Characteristic Curves

### ▪ Chromaticity Coordinate vs. Forward Current

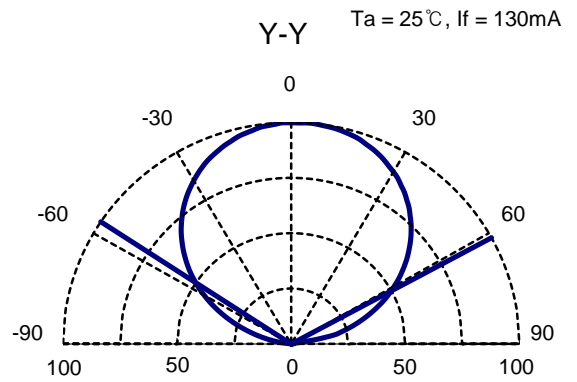
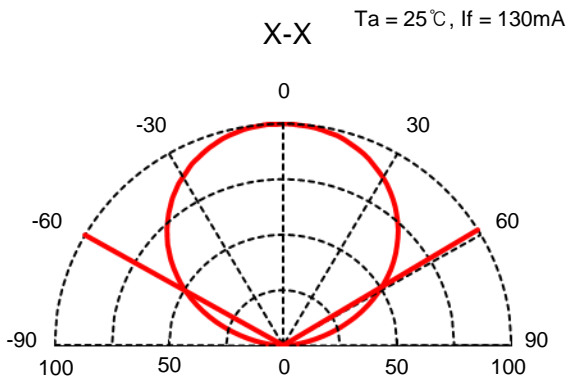


※ 5000K CCT data also applies to 5700K and 6500K CCTs and 3000K data also applies to 2700K, 3500K and 4000K CCTs.

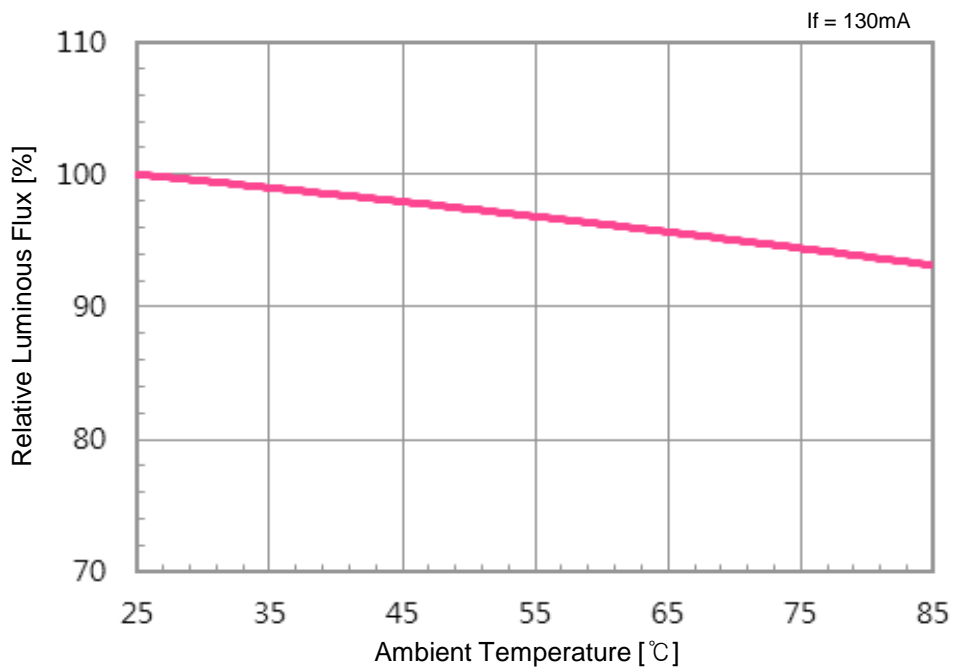


## 8. Typical Characteristic Curves

- Radiation Characteristics

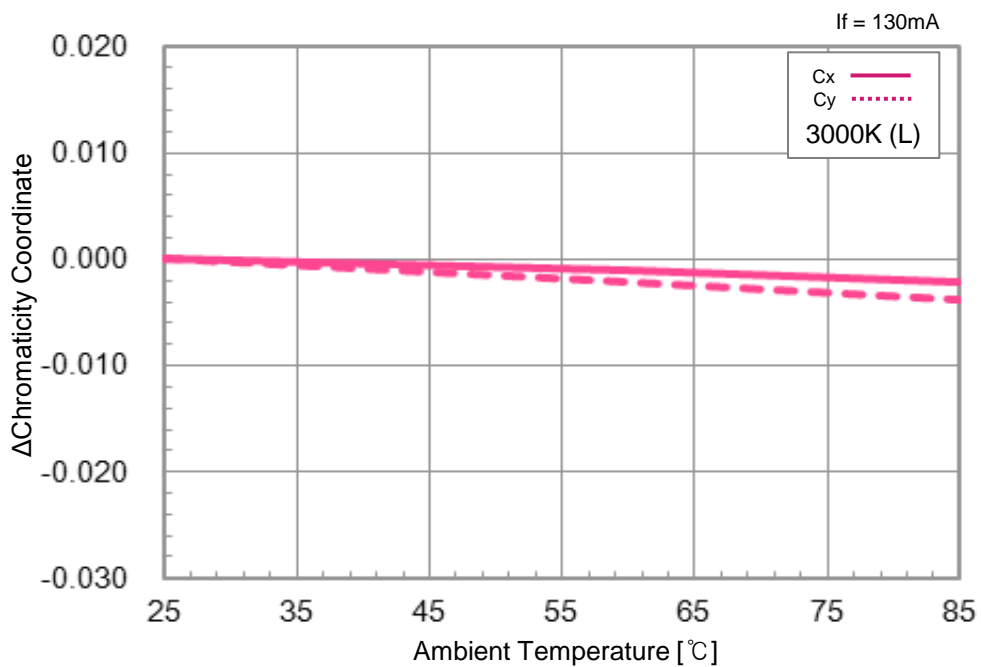
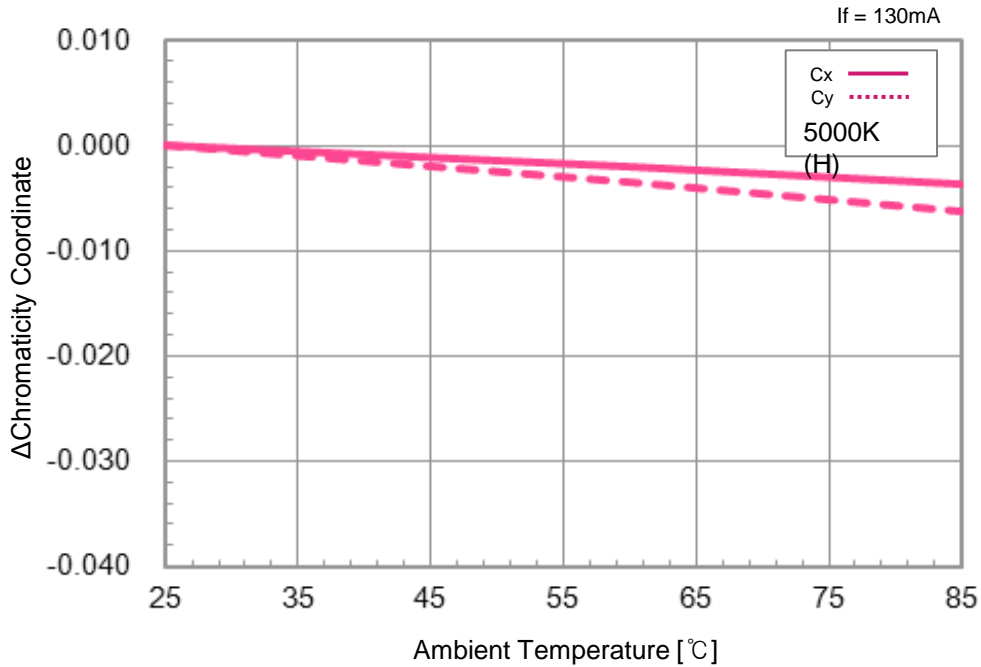


- Luminous Flux vs. Temperature



## 8. Typical Characteristic Curves

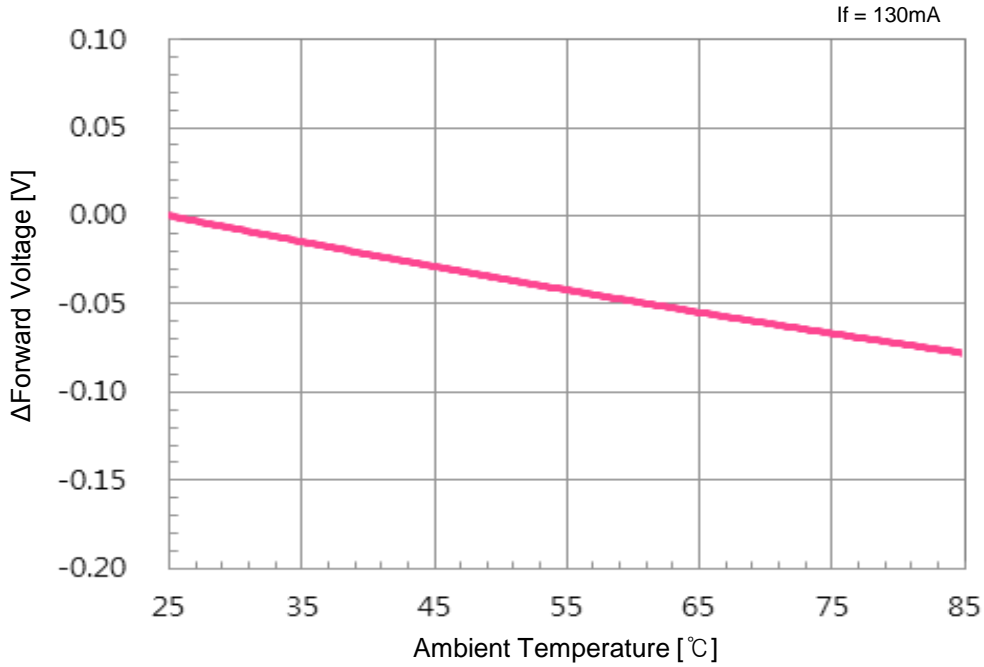
### ▪ Chromaticity Coordinate vs. Temperature



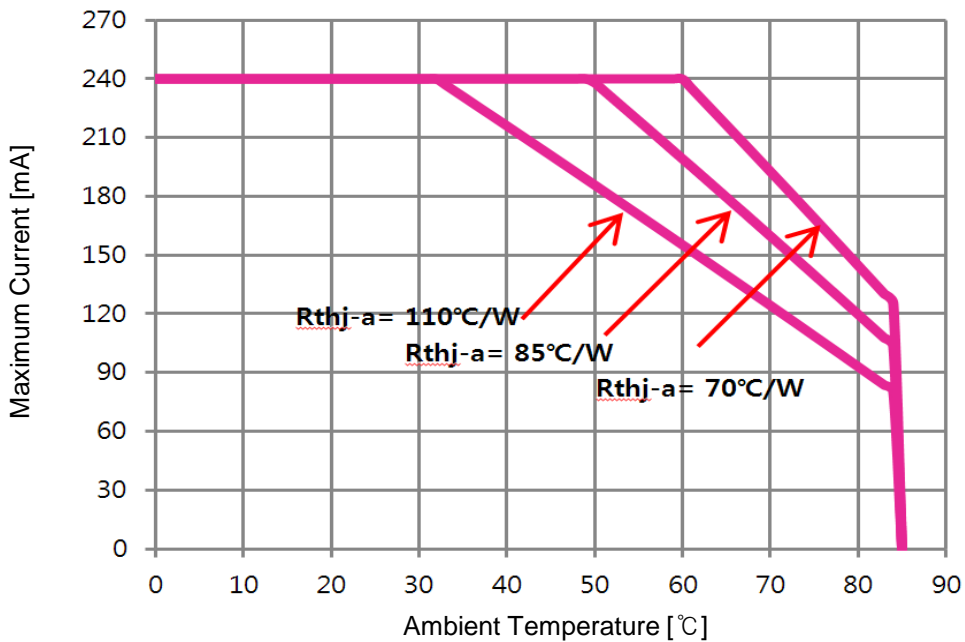
※ 5000K CCT data also applies to 5700K and 6500K CCTs and 3000K data also applies to 2700K, 3500K and 4000K CCTs.

## 8. Typical Characteristic Curves

### ▪ Forward Voltage vs. Temperature



### ▪ Derating Curve



※ The ambient temperature values for each graph are obtained with LG Innotek equipment.

## 9. Reliability Test Items and Conditions

### 9-1. Failure Criteria

Items	Symbols	Test Conditions	Limits	
			Min.	Max.
Forward Voltage	V <sub>f</sub>	I <sub>f</sub> = 180mA	-	Initial Value × 1.1
Luminous Flux	Φ <sub>v</sub>	I <sub>f</sub> = 180mA	Initial Value × 0.7	-

### 9-2. Reliability Tests

No	Items	Test Conditions	Test Hours /Cycles
1	Room Temperature Operating Life (RTOL)	T <sub>a</sub> = 25 °C, I <sub>f</sub> = 180mA	1,000 Hours
2	Wet High Temperature Operating Life (WHTOL)	T <sub>a</sub> = 60 °C, RH = 90%, I <sub>f</sub> = 180mA	1,000 Hours
3	High Temperature Operating Life (HTOL)	T <sub>a</sub> = 85 °C, I <sub>f</sub> = 180mA	1,000 Hours
4	Low Temperature Operating Life (LTOL)	T <sub>a</sub> = -40 °C, I <sub>f</sub> = 180mA	1,000 Hours
5	High Temperature Storage Life (HTSL)	T <sub>a</sub> = 100 °C	1,000 Hours
6	Low Temperature Storage Life (LTSL)	T <sub>a</sub> = -40 °C	1,000 Hours
7	Wet High Temperature Storage Life (WHTSL)	T <sub>a</sub> = 85 °C, RH = 85%	1,000 Hours
8	Thermal Shock (TMSK)	100 °C ~ -40 °C Dwell : 15 min., Transfer : 10 sec.	200 Cycles
9	Moisture Sensitivity Level (MSL)	T <sub>sld</sub> = 260 °C (Pre treatment 60 °C, 60%, 168 hours)	3 Times

※ All samples are tested using LG Innotek Standard Metal PCB (25x25x1.6 mm<sup>3</sup> (L×W×H)) except MSL test .

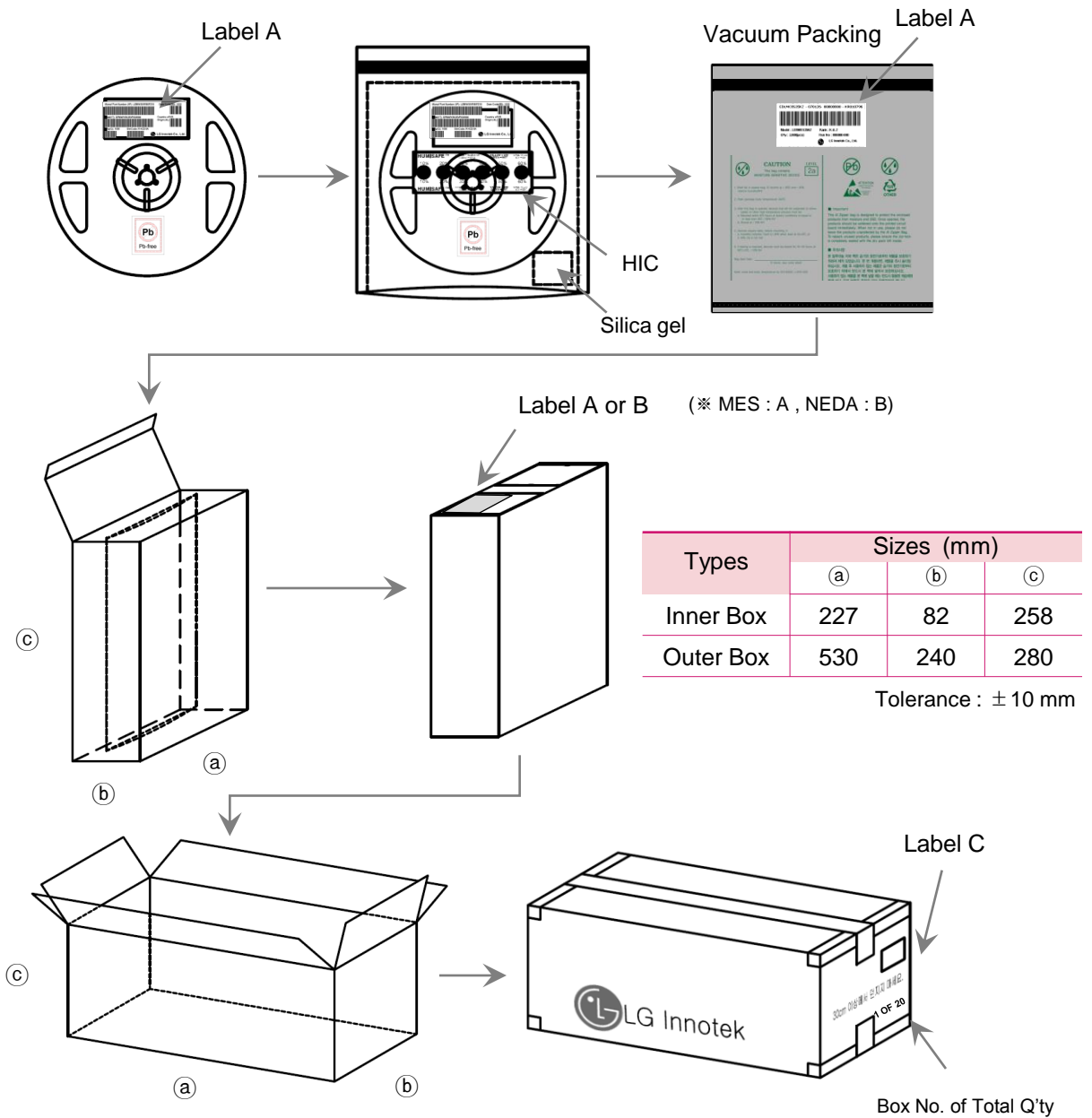
※ All samples must pass each test item and all test items must be satisfied.



# 10. Packing and Labeling of Product

## 10-2. Packing Structures

Reeled products are packed in a sealed-off and moisture-proof aluminum bag with desiccants (silica gel) and HIC (Humidity Indicator Card). A maximum of four aluminum bags are packed in an inner box and six inner boxes are packed in an outer box.

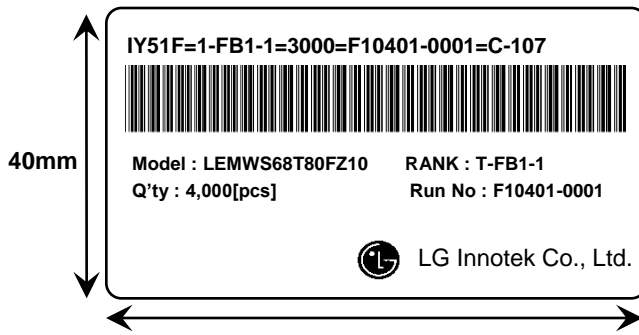


# 10. Packing and Labeling of Product

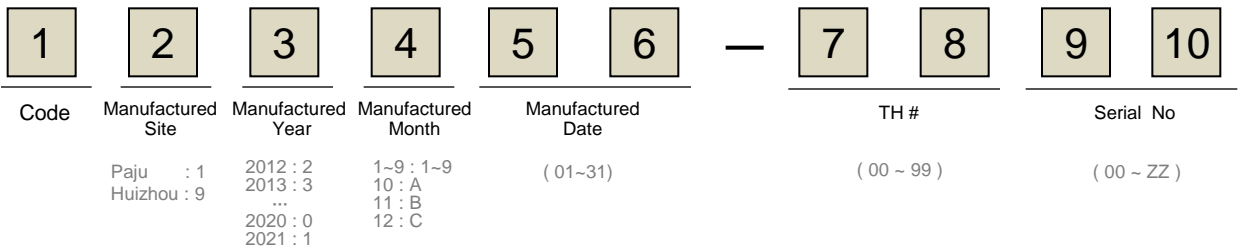
## 10-3. MES Label Structure

### ※ Label A

Specifying Lot ID, 'Model Name', 'MES ID', 'RANK', 'Q'ty', 'Run No.', 'Rack No.'

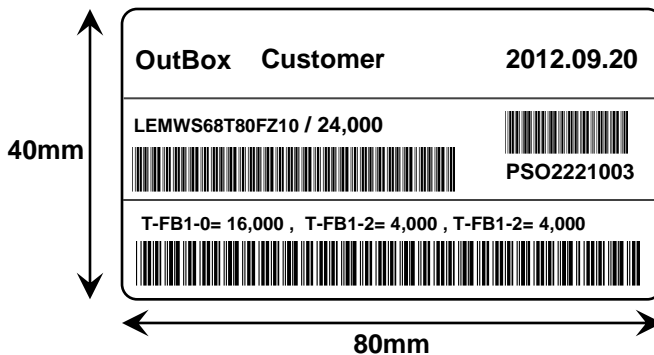


#### ▪ Run No. indication

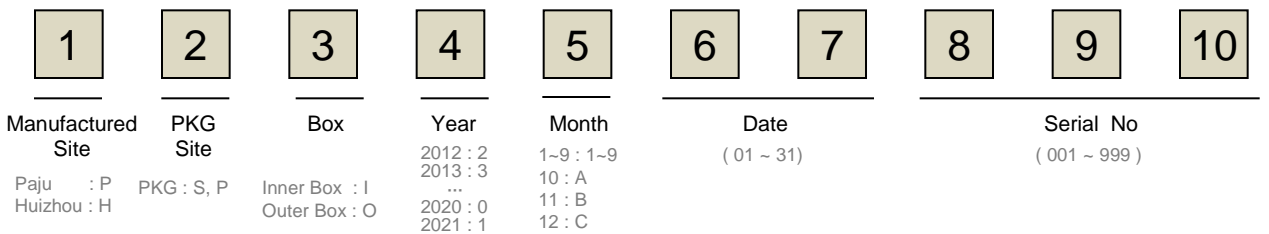


### ※ Label C

Specifying 'Customer', 'Date', 'Model Name', 'Quantity', 'Customer Part no.', 'Outbox ID', 'LGIT internal Model name'



#### ▪ Box ID. indication

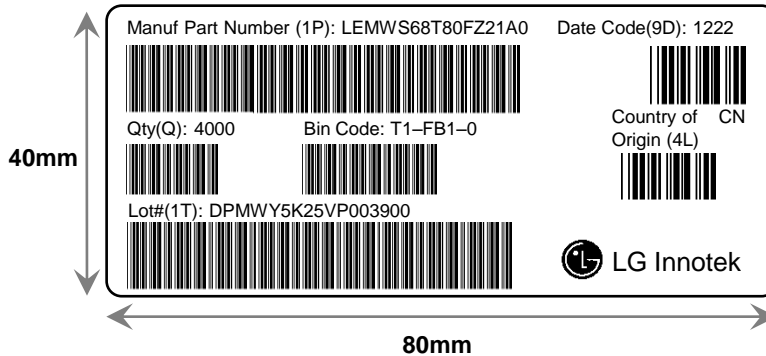


## 10. Packing and Labeling of Product

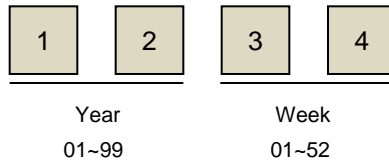
### 10-4. NEDA Label Structure

#### ※ Label A

Specifying 'Manufacturing Part Number', 'Quantity', 'Bin Code', 'Lot', 'Date Code' and 'Country of Origin'



#### ▪ Date Code(9D)

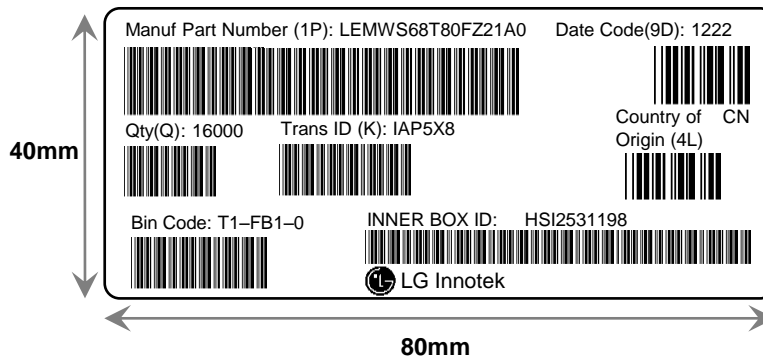


#### ▪ Lot#(1T)

LG Innotek Trace Code

#### ※ Label B

Specifying 'Manufacturing Part Number', 'Quantity', 'Bin Code', 'Trans ID', 'Date Code', 'Country of Origin' and 'Inner Box ID'





# 10. Packing and Labeling of Product

## 10-4. NEDA Label Structure

### ※ Label C

Specifying 'Manufacturing Site', 'Customer Address', 'Manufacturing Part Number', 'Bin Code', 'Box ID', 'Trans ID' and 'Quantity'



### ▪ Box ID indication

1	2	3	4	5	6	7	8	9	10
Site	Code	Outbox	Year	Month	Date		Serial No		
Paju: P Huizhou: H	S, P	Outbox: O Inbox: I	12 : 2 13 : 3 14 : 4 15 : 5	1~9 : 1~9 10 : A 11 : B 12 : C	( 01 ~ 31 )		( 001 ~ 999 )		

## 11. Cautions on Use

### 11-1. Moisture-Proof Package

- The moisture in the SMD package may vaporize and expand during soldering.
- The moisture can damage the optical characteristics of the LEDs due to the encapsulation.

### 11-2. During Storage

Conditions		Temperature	Humidity	Time
Storage	Before Opening Aluminum Bag	5°C ~ 30°C	< 50% RH	Within 1 Year from the Delivery Date
	After Opening Aluminum Bag	5°C ~ 30°C	< 60% RH	≤ 672 Hours
Baking		65 ± 5°C	< 10% RH	10 ~ 24 Hours

### 11-3. During Usage

- The LED should avoid the direct contact with hazardous materials such as sulfur, chlorine, phthalate, etc..
- The metal parts on the LED can rust when exposed to corrosive gases. Therefore, exposure to corrosive gases must be avoided during operation and storage.
- The silver-plated metal parts also can be affected not only by the corrosive gases emitted inside of the end-products but by the gases penetrated from outside environment.
- Extreme environments such as sudden ambient temperature changes or high humidity that can cause condensation must be avoided.

### 11-4. Cleaning

- Do not use brushes for cleaning or organic solvents (i.e. Acetone, TCE, etc..) for washing as they may damage the resin of the LEDs.
- IPA is the recommendable solvent for cleaning the LEDs under the following conditions.  
Clearing Condition : IPA, 25°C max. × 60 sec max.
- Ultrasonic cleaning is not recommended.
- Pretests should be conducted with the actual cleaning process to validate that the process will not damage the LEDs.

## 11. Cautions on Use

### 11-5. Thermal Management

- The thermal design of the end product must be thoroughly considered, particularly at the beginning of the end product design process.
- The generation of heat is greatly impacted by the input power, the thermal resistance of the circuit boards and the density of the LED array combined with other components.

### 11-6. Static Electricity

- Wristbands and anti-electrostatic gloves are strongly recommended and all devices, equipment and machinery must be properly grounded when handling the LEDs, which are sensitive against static electricity and surge.
- Precautions are to be taken against surge voltage to the equipment that mounts the LEDs.
- Unusual characteristics such as significant increase of current leakage, decrease of turn-on voltage, or non-operation at a low current can occur when the LED is damaged.

### 11-7. Recommended Circuit

- The current through each LED must not exceed the absolute maximum rating when designing the circuits.
- In general, the LED forward voltages can vary. LEDs in parallel that have different forward voltages in combination with a single resistor can result in different forward currents to each LED, which can also output different luminous flux values. In the worst case, the currents can exceed the absolute maximum ratings which can stress the LEDs. Matrix circuit with a single resistor for each LED is recommended to avoid luminous flux fluctuations.

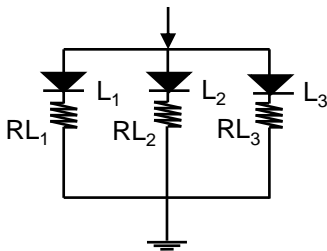


Fig.1 Recommended Circuit in Parallel Mode  
: Separate resistors must be used for each LED.

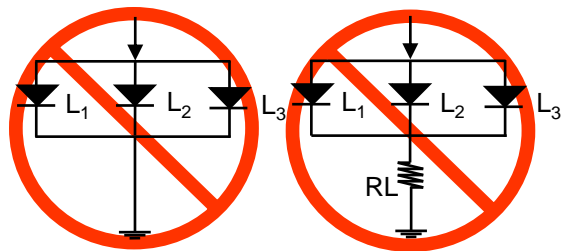


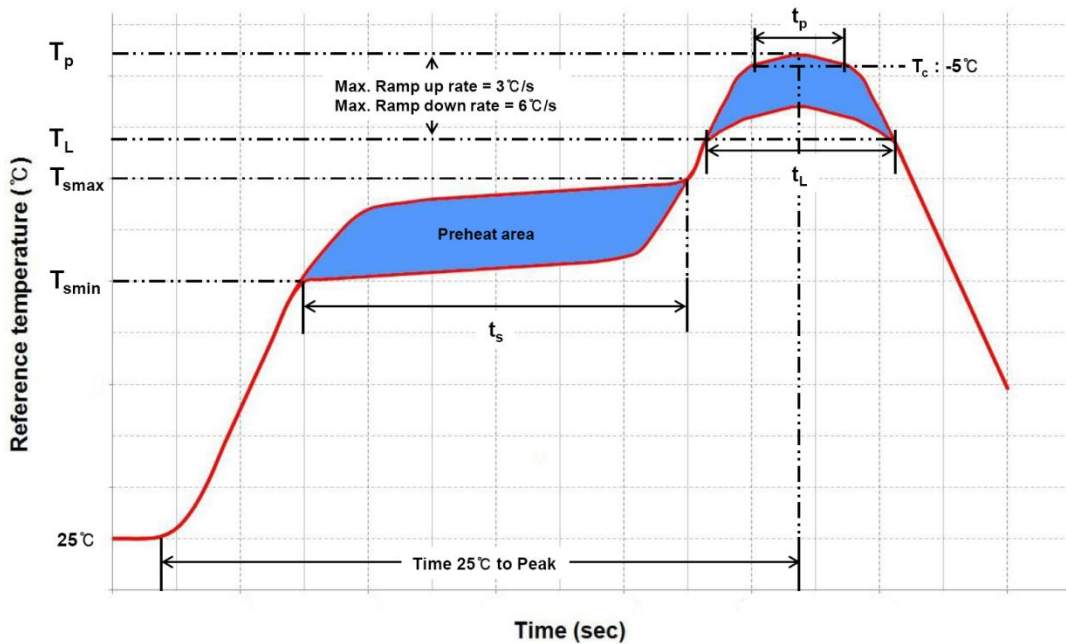
Fig.2. Abnormal Circuit  
Circuits to Avoid: The current through the LEDs may vary due to the variation in LED forward voltage.

- The driving circuits must be designed to operate the LEDs by forward bias only.
- Reverse voltages can damage the zener diode, which can cause the LED to fail.
- A constant current LED driver is recommended to power the LEDs.

## 11. Cautions on Use

### 11-8. Soldering Conditions

- Reflow soldering is the recommended method for assembling LEDs on a circuit board.
- LG Innotek does not guarantee the performance of the LEDs assembled by the dip soldering method.
- Recommended Soldering Profile (according to JEDEC J-STD-020D)



Profile Feature	Pb-Free Assembly	Pb-Based Assembly
Preheat/Soak		
Temperature Min( $T_{smin}$ )	150°C	100°C
Temperature Max( $T_{smax}$ )	200°C	150°C
Maximum time( $t_s$ ) from $T_{smin}$ to $T_{smax}$	60~120 seconds	60~120 seconds
Ramp-up rate ( $T_L$ to $T_p$ )	3°C/ second max.	3°C/ second max.
Liquidous temperature ( $T_L$ )	217°C	183°C
Time ( $t_L$ ) maintained above $T_L$	60~150 seconds	60~150 seconds
Maximum peak package body temperature ( $T_p$ )	260°C	235°C
Time( $t_p$ ) within 5°C of the specified temperature ( $T_c$ )	30 seconds	20 seconds
Ramp-down rate ( $T_p$ to $T_L$ )	6°C/second max.	6°C/second max.
Maximum Time 25°C to peak temperature	8 minutes max.	6 minutes max.

- Reflow or hand soldering at the lowest possible temperature is desirable for the LEDs although the recommended soldering conditions are specified in the above diagrams.
- A rapid cooling process is not recommended for the LEDs from the peak temperature.
- The silicone encapsulant at the top of the LED package is a soft surface, which can easily be damaged by pressure. Precautions should be taken to avoid strong pressure on the silicone resin when leveraging the pick and place machines.
- Reflow soldering should not be done more than two times.

## 11. Cautions on Use

### 11-9. Soldering Iron

- The recommended condition is less than 5 seconds at 260 °C.
- The time must be shorter for the higher temperatures. (+10 °C → -1sec).
- The power dissipation of the soldering iron should be lower than 15W and the surface temperature of the device should be controlled at or under 230 °C.

### 11-10. Eye Safety Guidelines

- Do not directly look at the light when the LEDs are on.
- Proceed with caution to avoid the risk of damage to the eyes when examining the LEDs with optical instruments.

### 11-11. Manual Handling

- Use Teflon-type tweezers to grab base of LED and do not apply mechanical pressure on the surface of the encapsulant.



## Appendix. Nomenclature of Package

All LEDs are tested and sorted by color, luminous flux and forward voltage where every LED in a tube has only a single color bin, luminous flux bin and forward voltage bin. However, the forward voltage bin information is not captured in the part number nomenclature.

A 16-digit part number is required when orders are placed. LG Innotek leverages the following part number nomenclature.

